Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED
C-10 Package Outline Drawing

NOTES:
1. PACKAGE, LEADS, COVER MATERIAL: KOVAR™
2. SPACER MATERIAL: ALUMINUM
3. PLATING: ELECTROLYTIC GOLD 50 MICROINCHES MIN., OVER ELECTROLYTIC NICKEL 75 MICROINCHES MIN.
4. ALL DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. TOLERANCES ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED.
6. FIELD REPLACEABLE 2.92mm CONNECTORS.
   TENSOLITE 231CCSF OR EQUIVALENT.

Typical Package Weight

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<tr>
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<th>Weight</th>
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<tbody>
<tr>
<td>Package</td>
<td>18.7 gms</td>
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<tr>
<td>Spacer</td>
<td>3.3 gms</td>
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<tr>
<td>+/- 1 gms Tolerance</td>
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For price, delivery, and to place orders, please contact Hittite Microwave Corporation:
20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373
Order On-line at www.hittite.com
C-10B Package Outline Drawing

NOTES:
1. PACKAGE, LEADS, COVER MATERIAL: KOVAR™
2. SPACER MATERIAL: ALUMINUM
3. PLATING: ELECTROLYTIC GOLD 50 MICROINCHES MIN., OVER ELECTROLYTIC NICKEL 75 MICROINCHES MIN.
4. ALL DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. TOLERANCES ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED.
6. FIELD REPLACEABLE 2.92mm CONNECTORS.
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